



Product Change Notification

Change Notification #: 118983-00
Change Title: Intel® Server System R1208WFTZSR,
PCN 118983-00, Product Design, Product
Material,
Adding Second Source Component Updates
Date of Publication: March 22, 2022

Key Characteristics of the Change:

Product Design, Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*	April 08, 2022
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the items listed in the "Products Affected" table.

*Adding a second source for the Over Current Protection (OCP) Integrated Circuit (IC) on the Server Board. The new IC is identical in form factor and function to the previous one.

- As a result, we are adding as alternates the following Server Board PBA:
M71494-951/-961.

*Adding a second source for a Voltage Regulator (VR) controller on the Hot swap backplanes (HSBP). The new controller is identical in function to the previous one but differs in form factor.

- As a result, we are adding as alternate the following PBA in the Hot swap backplane: H88382-401.
Also, using the interposer PCB supporting a new Programmable System-On-Chip (PSOC), we have the following PBA: H88382-411 being added as alternate.

The new components have passed all functional and electrical validation tests successfully.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Server System R1208WFTZSR, Single	R1208WFTZSR	99AW7C	M64555-001	H48104-961 H48104-951 H88382-351 H88382-352	M64555-002	H48104-961 H48104-951 M71494-951 M71494-961 H88382-351 H88382-352 H88382-401 H88382-411

PCN Revision History:

Date of Revision:

March 22, 2022

Revision Number:

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Reason:

Originally Published PCN



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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

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